

# AO4496

# N-Channel Enhancement Mode Field Effect Transistor



# **General Description**

The AO4496/L uses advanced trench technology to provide excellent R<sub>DS(ON)</sub> with low gate charge. This device is suitable for use as a DC-DC converter application. AO4496 and AO4496L are electrically identical.

- -RoHS Compliant
- -AO4496L is Halogen Free

### **Features**

 $V_{DS}(V) = 30V$ 

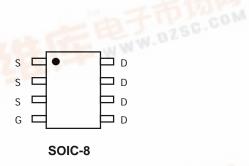
 $I_D = 10A$  (V<sub>GS</sub> = 10V)

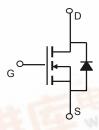
 $R_{DS(ON)}$  < 19.5m $\Omega$  ( $V_{GS}$  = 10V)

 $R_{DS(ON)} < 26m\Omega$  (V<sub>GS</sub> = 4.5V)

UIS TESTED!

Rg, Ciss, Coss, Crss Tested





Absolute Maximum Ratings T <sub>J</sub> =25°C unless otherwise noted							
Parameter Drain-Source Voltage Gate-Source Voltage		Symbol	Maximum	Units			
		$V_{DS}$	30	V			
		$V_{GS}$	±20				
Continuous Drain	T <sub>A</sub> =25°C		10	一年场四			
Current <sup>A</sup>	T <sub>A</sub> =70°C	I <sub>D</sub>	7.5	Asc.GC			
Pulsed Drain Current <sup>B</sup>		I <sub>DM</sub>	50	W.DZSU			
Avalanche Current <sup>G</sup>		I <sub>AR</sub>	17	1000			
Repetitive avalanche energy L=0.1mH <sup>G</sup>		E <sub>AR</sub>	14	mJ			
Power Dissipation <sup>A</sup>	T <sub>A</sub> =25°C	D	3.1	W			
	T <sub>A</sub> =70°C	P <sub>D</sub>	2.0	VV			
Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C			

Thermal Characteristics								
Parameter		Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\scriptscriptstyle{ hetaJA}}$	31	40	°C/W			
Maximum Junction-to-Ambient A	Steady State	ady State		75	°C/W			
Maximum_Junction-to-Lead <sup>C</sup>	Steady State	$R_{ hetaJL}$	16	24	°C/W			

#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units			
STATIC PARAMETERS									
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$	30			V			
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V			1	μА			
500		T <sub>J</sub> = 55°C			5	μ. (			
$I_{GSS}$	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA			
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$	1.4	1.8	2.5	V			
$I_{D(ON)}$	On state drain current	$V_{GS}$ = 10V, $V_{DS}$ = 5V	50			Α			
	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A		16	19.5				
$R_{DS(ON)}$		T <sub>J</sub> =125°C		24	29	mΩ			
		$V_{GS} = 4.5V, I_D = 7.5A$		21	26				
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5V, I_{D} = 10A$		30		S			
$V_{SD}$	Diode Forward Voltage	$I_S = 1A, V_{GS} = 0V$		0.76	1	V			
$I_S$	Maximum Body-Diode Continuous Current				3	Α			
DYNAMIC	PARAMETERS								
C <sub>iss</sub>	Input Capacitance			550	715	pF			
C <sub>oss</sub>	Output Capacitance	$V_{GS}$ =0V, $V_{DS}$ =15V, f=1MHz		110		pF			
C <sub>rss</sub>	Reverse Transfer Capacitance	]		55		pF			
$R_g$	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz	3	4	5.5	Ω			
SWITCHII	NG PARAMETERS								
Q <sub>g</sub> (10V)	Total Gate Charge			9.8	13	nC			
Q <sub>g</sub> (4.5V)	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =10A		4.6	6.1	nC			
$Q_{gs}$	Gate Source Charge	V <sub>GS</sub> -10V, V <sub>DS</sub> -13V, I <sub>D</sub> -10A		1.8		nC			
$Q_{gd}$	Gate Drain Charge	1 [		2.2		nC			
$t_{D(on)}$	Turn-On DelayTime			5		ns			
t <sub>r</sub>	Turn-On Rise Time	$V_{GS}$ =10V, $V_{DS}$ =15V, $R_{L}$ = 1.5 $\Omega$ ,		3.2		ns			
$t_{D(off)}$	Turn-Off DelayTime	$R_{GEN}$ =3 $\Omega$		24		ns			
t <sub>f</sub>	Turn-Off Fall Time	] [		6		ns			
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =10A, dI/dt=100A/μs		22	29	ns			
$Q_{rr}$	Body Diode Reverse Recovery Charge	I <sub>F</sub> =10A, dI/dt=100A/μs		14		nC			

A: The value of R  $_{0.JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T $_A$  = 25°C. The value in any given application depends on the user's specific board design.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead R  $_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using  $t \le 300 \mu s$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub>=25°C. The SOA curve provides a single pulse rating.

F. The current rating is based on the  $t \le 10s$  thermal resistance rating.

G.  $E_{AR}$  and  $I_{AR}$  ratings are based on low frequency and duty cycles to keep  $T_j$ =25C.

#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

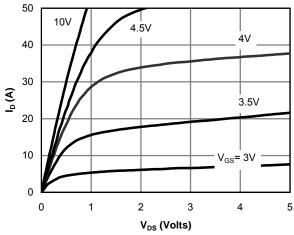


Figure 1: On-Region Characteristics

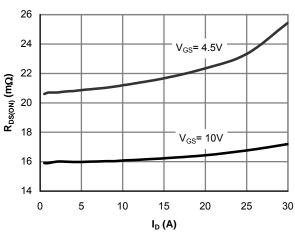


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

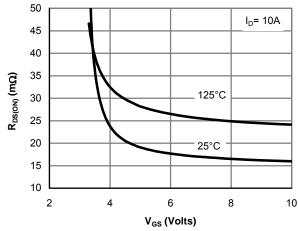


Figure 5: On-Resistance vs. Gate-Source Voltage

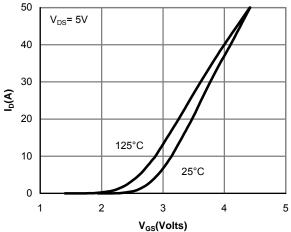


Figure 2: Transfer Characteristics

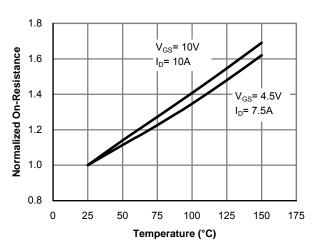


Figure 4: On-Resistance vs. Junction Temperature

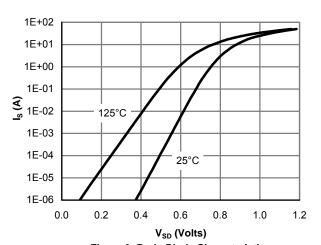
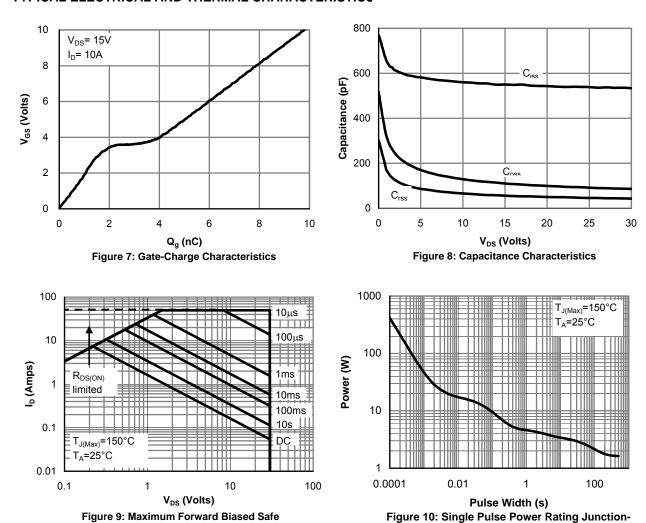


Figure 6: Body-Diode Characteristics

#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Operating Area (Note E)



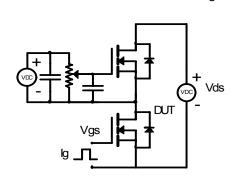
10  $D=T_{on}/T$ In descending order D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse  $T_{J,PK}=T_A+P_{DM}.Z_{\theta JA}.R_{\theta JA}$ Z<sub>eJA</sub> Normalized Transient <sub>θJA</sub>=75°C/W Thermal Resistance 0.1 0.01 Single Pulse 0.001 0.00001 0.0001 0.001 0.01 0.1 10 100 1000 Pulse Width (s)

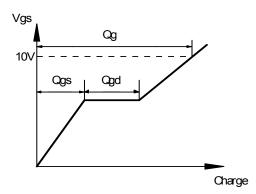
Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

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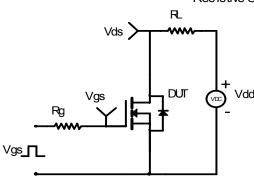
to-Ambient (Note E)

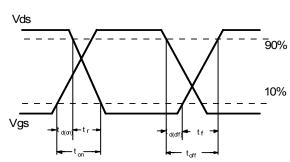
# Gate Charge Test Circuit & Waveform



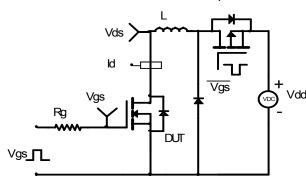


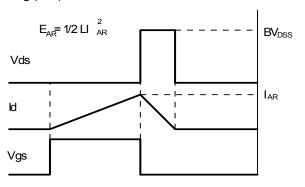
Resistive Switching Test Circuit & Waveforms





Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





# Diode Recovery Test Circuit & Waveforms

